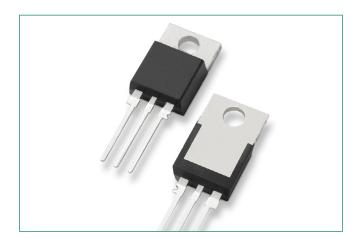
# MCR69-2, MCR69-3

Silicon Controlled Rectifiers - 400V - 800V





#### **Additional Information**







Accessories



Samples

#### **Functional Diagram**



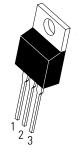
## **Description**

Designed for overvoltage protection in crowbar circuits.

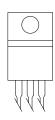
#### **Features & Benefits**

- Glass-Passivated Junctions for Greater Parameter Stability and Reliability
- Center-Gate Geometry for Uniform Current Spreading Enabling High Discharge Current
- Small Rugged, Thermowatt Package Constructed for Low Thermal Resistance and Maximum Power Dissipation and Durability
- High Capacitor Discharge Current, 750 Amps
- Pb-Free Packages are Available

#### **Pin Out**



TO-220AB Case 221A Style 3





#### **Maximum Ratings** (T<sub>1</sub> = 25°C unless otherwise noted)

Rating	Part Number	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) $(T_J = -40 \text{ to } +125^{\circ}\text{C}, \text{ Gate Open})$			50 100	V
Peak Discharge Current (Note 2)		I <sub>TM</sub>	750	А
On-State RMS Current (180° Conduction Angles; $T_c = 85$ °C)		I <sub>T (RMS)</sub>	25	А
Average On-State Current (180° Conduction Angles; $T_c = 80$ °C)		I <sub>T(AV)</sub>	16	А
Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave, 60 Hz, T	= 125°C)	I <sub>TSM</sub>	300	А
Circuit Fusing Considerations (t = 8.3 ms)			375	A <sup>2</sup> sec
Forward Peak Gate Current (t $\leq$ 1.0 $\mu$ s, T <sub>C</sub> = 85°C)			2.0	А
Forward Peak Gate Power (t ≤ 1.0µs, T <sub>c</sub> = 85°C)			20	W
Operating Junction Temperature Range			-40 to +125	°C
Storage Temperature Range			-40 to +150	°C
Mounting Torque		T <sub>stg</sub>	8.0	in. lb.

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. VDRM and VRRM for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall

not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

2. Ratings apply for tw = 1 ms. See Figure 1 for ITM capability for various duration of an exponentially decaying current waveform, tw is defined as 5 time constants of an exponentially decaying current pulse.

3. Test Conditions: I<sub>6</sub> = 150 mA, V<sub>0</sub> = Rated V<sub>DRM</sub>, I<sub>IM</sub> = Rated Value, T<sub>J</sub> = 125°C.

#### **Thermal Characteristics**

Characterstic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	R <sub>euc</sub>	1.5	°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>eJA</sub>	60	C/VV
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	T <sub>L</sub>	260	°C

#### **Electrical Characteristics - OFF** (T<sub>J</sub> = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Forward or Reverse Blocking Current	$T_J = 25^{\circ}C$	I <sub>DRM</sub>	-	-	10	μΑ
$(V_{AK} = V_{DRM} = V_{RRM}; Gate Open)$	T <sub>1</sub> = 125°C	I	-	-	2.0	mA

#### **Electrical Characteristics - ON**

Characteristic			Min	Тур	Max	Unit
	(Note 4) $(I_{TM} = 50 \text{ A})$		_	_	1.8	
Peak Forward On–State Voltage	$(I_{TM} = 750 \text{ A, tw} = 1 \text{ ms})$ (Note 5)	$V_{TM}$	-	6.0	_	V
Gate Trigger Current (Continuous dc) ( $V_D = 12 \text{ V}, R_I = 100 \Omega$ )		I <sub>GT</sub>	2.0	7.0	30	mA
Gate Trigger Voltage (Continuous dc) ( $V_D = 12 \text{ Vdc}, R_1 = 100 \Omega$ )		$V_{\rm GT}$	_	0.65	1.5	V
Gate Non-Trigger Voltage (Continuous dc) ( $V_D = 12 \text{ Vdc}$ , $R_L = 100 \Omega$ , $T_J = 125^{\circ}\text{C}$ )		$V_{GD}$	0.2	0.40	-	V
Holding Current (V <sub>D</sub> = 12 Vdc, Initiating Current = 200 mA, Gate Open)		I <sub>H</sub>	3.0	15	50	mA
Latch Current ( $V_D = 12 V_{DC'} I_G = 150 \text{ mA}$ )		IL	-	_	60	mA
Gate Controlled Turn-On Time (Note 6) ( $V_D$ = Rated $V_{DRM'}$ ( $I_{TM}$ = 50 A Peak)	<sub>g</sub> = 150 mA)	t <sub>gt</sub>	-	1.0	-	μs



#### **Dynamic Characteristics**

Characteristic		Min	Тур	Max	Unit
Critical Rate-of-Rise of Off-State Voltage ( $V_D$ = Rated $V_{DRM'}$ , Exponential Waveform, Gate Open, $T_J$ = 125°C)	dv/dt	10	_	_	V/µs
Critical Rate of Rise of On–State Current $I_g$ = 150 mA , $T_J$ = 125°C	di/dt	_	_	100	A/µs

<sup>4.</sup> Pulse duration  $\leq 300 \ \mu s$ , duty cycle  $\leq 2\%$ .

## **Voltage Current Characteristic of SCR**

Symbol	Parameter
$V_{DRM}$	Peak Repetitive Forward Off State Voltage
I <sub>DRM</sub>	Peak Forward Blocking Current
$V_{_{\mathrm{RRM}}}$	Peak Repetitive Reverse Off State Voltage
I <sub>RRM</sub>	Peak Reverse Blocking Current
$V_{TM}$	Maximum On State Voltage
I.,	Holding Current

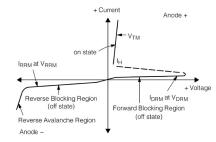


Figure 1. Typical RMS Current Derating

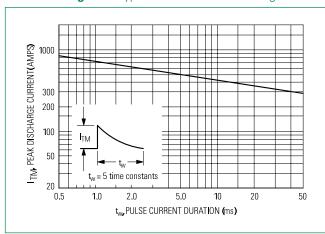


Figure 2. Peak Capacitor Discharge Current Derating

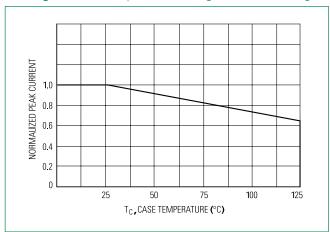


Figure 3. Current Derating

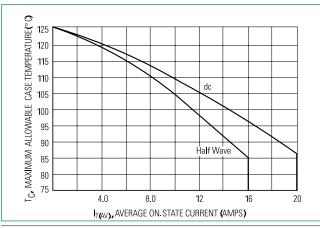
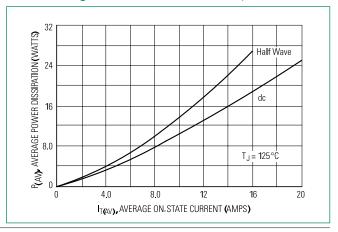


Figure 4. Maximum Power Dissipation

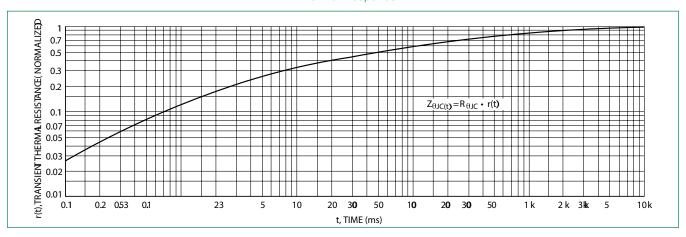




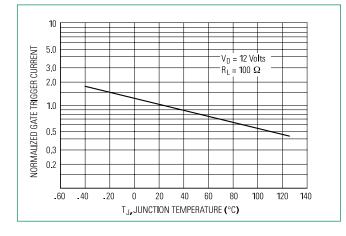
<sup>5.</sup> Ratings apply for tw = 1 ms. See Figure 1 for I<sub>IN</sub> capability for various durations of an exponentially decaying current waveform. tw is defined as 5 time constants of an exponentially decaying current pulse.

<sup>6.</sup> The gate controlled turn-on time in a crowbar circuit will be influenced by the circuit inductance.

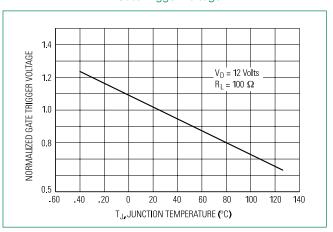
**Figure 5.**Thermal Response



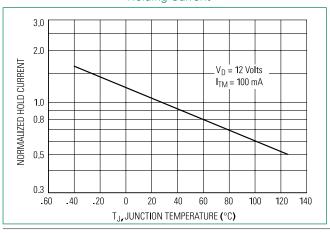
**Figure 6.**Gate Trigger Current



**Figure 7.**Gate Trigger Voltage



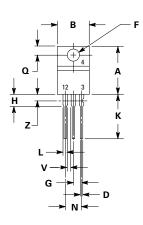
**Figure 8.** Holding Current

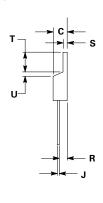




# MCR69-2, MCR69-3 Silicon Controlled Rectifiers – 400V - 800V

#### **Dimensions**



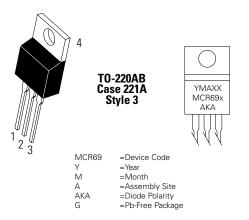


Pin Assignment			
1	Cathode		
2	Anode		
3	Gate		
4	Anode		

Dim	Inc	hes	Millin	neters
Dim	Min	Max	Min	Max
Α	0.590	0.620	14.99	15.75
В	0.380	0.420	9.65	10.67
С	0.178	0.188	4.52	4.78
D	0.025	0.035	0.64	0.89
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.41	2.67
Н	0.110	0.130	2.79	3.30
J	0.018	0.024	0.46	0.61
K	0.540	0.575	13.72	14.61
L	0.060	0.075	1.52	1.91
N	0.195	0.205	4.95	5.21
Q	0.105	0.115	2.67	2.92
R	0.085	0.095	2.16	2.41
S	0.045	0.060	1.14	1.52
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

## 1. Dimensioning and tolerancing per ansi y14.5m, 1982.

## **Part Marking System**



Device	Package	Shipping
MCR69-2	TO-220AB	
MCR69-2G	TO-220AB (Lead-Free)	1000 / Box
MCR69-3	TO-220AB	1000 / BOX
MCR69-3G	TO-220AB (Lead-Free)	

**Ordering Information** 

Disclaimer Notice - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at http://www.littelfuse.com/disclaimer-electronics.



<sup>2.</sup> Controlling dimension: inch.
3. Dimension z defines a zone where all body and lead irregularities are allowed.

# 单击下面可查看定价,库存,交付和生命周期等信息

# >>Littelfuse(美国力特)